

HICUM Models - A Status Overview

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OUTLINE

- HICUM/L2
 - V2.30 release
 - Model Support
 - Experimental verification
 - Model Run-time comparison
- HICUM/L0 Support Activities

HICUM/L2

- New *HICUM/L2 version 2.30* model
=> final code *released publicly* on 24th May, 2011
- New release note describing all extensions and changes and CMC suggested QA results are available on web

Users are requested to fill out brief questionnaire for code access

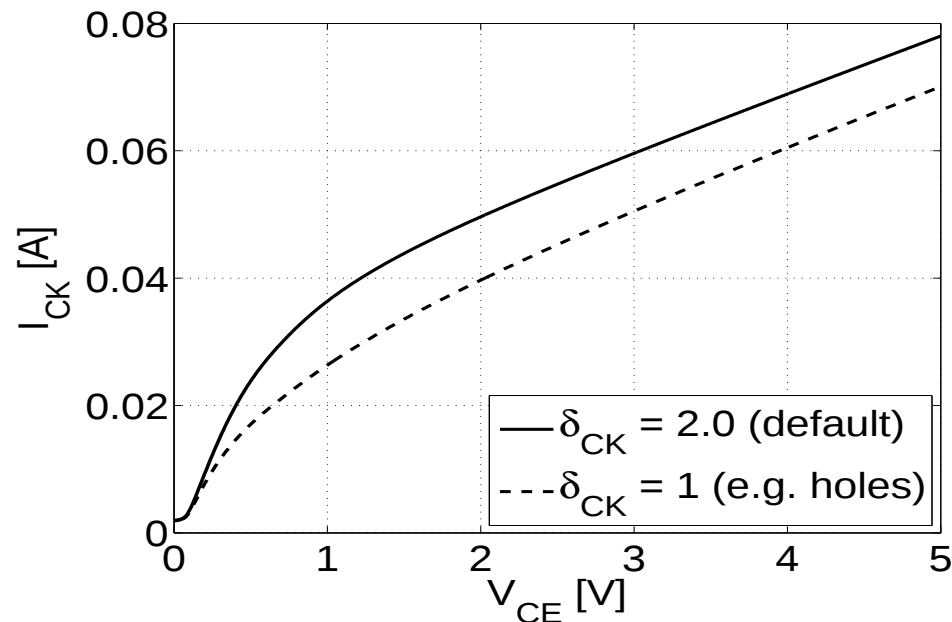
- helps us to keep track of users
 - requires users to acknowledge copyrights
 - CR notice is also included into the code
-
- summary of improvements described on next slides
-
- tests were run in
 - SPECTRE
 - ADS

New features

Modified formulation of critical current (I_{CK})

$$I_{CK} = \frac{v_{ceff}}{r_{Ci0}} \cdot \frac{1}{\left[1 + \left(\frac{v_{ceff}}{V_{lim}}\right)^{\delta_{CK}}\right]^{1/\delta_{CK}}} \left[1 + \frac{x + \sqrt{x^2 + a_{ickpt}}}{2}\right]$$

- **Default $\delta_{CK} = 2$** compatible with previous versions (typical for npn)



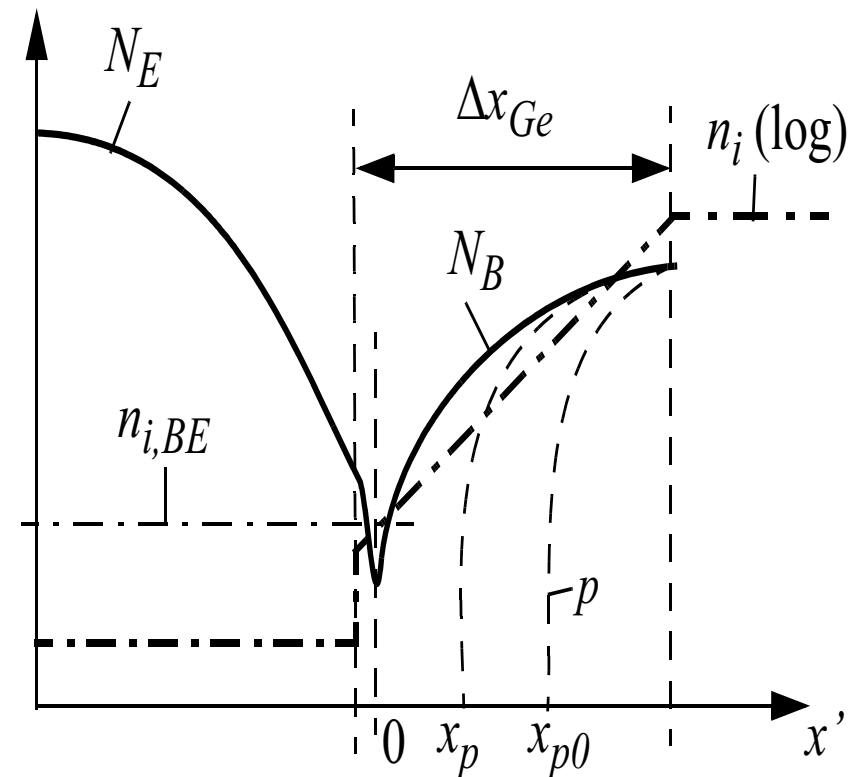
New features (cont'd.)

transfer current: weight factor for BE depletion charge

- compositional Ge grading causes different weighting of charge stored close to BE junction (Q_{jEi} , Q_f) compared to zero-bias charge Q_{p0}

$$h_{jEi} = h_{jEi0} \frac{\exp \left[a_{hjEi} \left(1 - \left(1 - \frac{V_{BEi}}{V_{DEi}} \right)^{z_{Ei}} \right) \right]}{a_{hjEi} \left(1 - \left(1 - \frac{V_{BEi}}{V_{DEi}} \right)^{z_{Ei}} \right)}$$

- Default** $a_{hjEi} = 0$ is compatible with previous versions



=> crucial for high-performance technologies

New features (cont'd.)

transfer current: weight factors for the minority charge

- Newly added weight factor h_{f0} for *low-injection minority charge*

$$Q_{f,T} = h_{f0}Q_{f0} + h_{fE}\Delta Q_{fE} + \Delta Q + h_{fC}\Delta Q_{fC}$$

- *default $h_{f0} = 1$* compatible with previous version
- caused by significant charge contribution from outside neutral base

=> very important for high-performance technologies

- High current weight factors h_{fE} and h_{fC} are modeled *temperature dependent*

New features (cont'd.)

minority charge: BC barrier effect explicitly included

- bias dependent barrier voltage

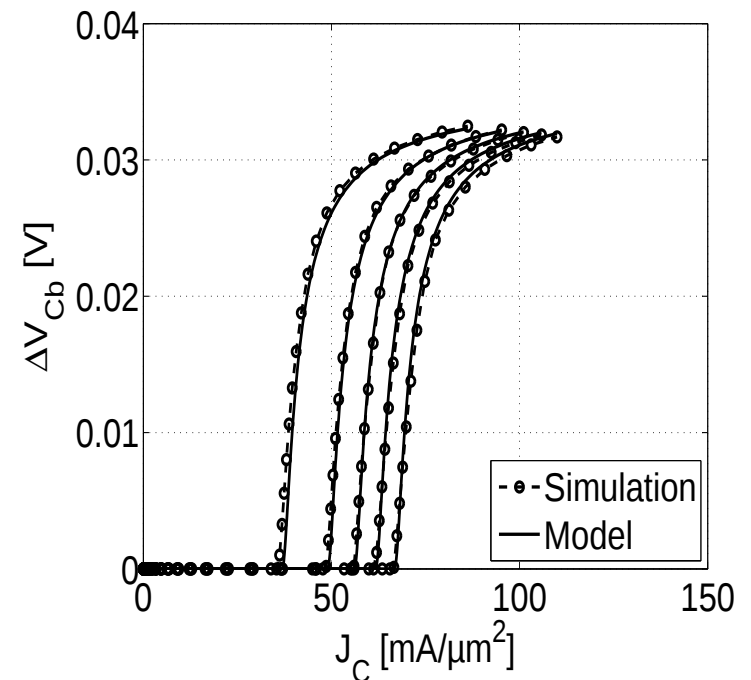
$$\Delta V_{cBar} = V_{cBar} \exp\left(-\frac{2}{i_{Bar} + \sqrt{i_{Bar}^2 + a_{cBar}}}\right)$$

with $i_{Bar} = (i_{Tf} - I_{CK})/i_{cBar}$

- $V_{cBar} = 0$ turns off extension
- new barrier related minority charge in base region:

$$\Delta Q_{Bf,b} = \tau_{Bfvs} i_{Tf} \left[\exp\left(\frac{\Delta V_{cBar}}{V_T}\right) - 1 \right]$$

=> important for high-performance technologies



New features (cont'd.)

- Modification of temperature dependent BE recombination currents

$$I_{RE(i,p)S}(T) = I_{RE(i,p)S0} \left(\frac{T}{T_0} \right)^{\frac{m_g}{m_{RE(i,p)}}} \exp \left[\frac{1}{m_{RE(i,p)}} \frac{V_{gBEeff}}{V_T} \left(\frac{T}{T_0} - 1 \right) \right]$$

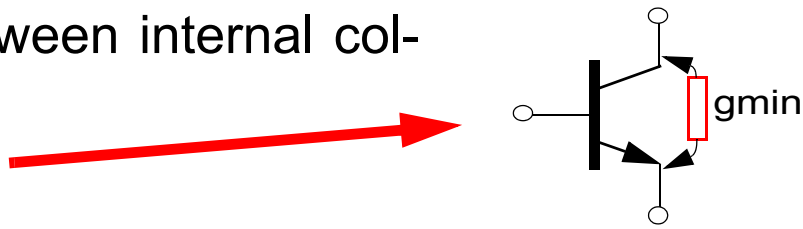
- setting $flcomp=2.2$ reduces the equation to that of previous versions
- Additional flicker noise contribution for emitter resistance R_E

$$\overline{I_{rE}^2} = \frac{K_{fre} \cdot I_E^{A_{fre}}}{f} + \frac{4kT}{R_E} \quad (\text{default } K_{fre} = 0)$$

- Thermal resistance is modeled temperature dependent

$$R_{th}(T) = R_{th}(T_0) \left(\frac{T}{T_0} \right)^{\zeta_{rth}} \quad (\text{default } \zeta_{rth} = 0)$$

New features (cont'd.)

- **Lateral NQS effect**: switch back to version 2.23 implementation
=> use of "*ddx*" operator *only* for determination of *diffusion capacitances*
(see slides of last meeting)
 - **Added additional "*Gmin* ($=1e-12$)"** between internal collector & emitter node
=> for transfer current (I_T) source
- 
- The diagram shows a BJT model with a base terminal on the left, a collector terminal at the top, and an emitter terminal at the bottom. A red arrow points from the text '=> for transfer current (I_T) source' to a conductance labeled 'gmin' connected between the internal collector and emitter nodes.
- Temperature dependence of emitter transit time *tef0* is removed
 - setting *flcomp*=2.2 or *lower* makes former equations available
 - **Backward compatibility options through flag *flcomp***:
 - *flcomp* = 0 or 2.1 => old temperature dependence (v2.1 or older)
 - *flcomp* = 2.2 => temperature dependent equations of previous versions
 - *flcomp* = 2.3 => temperature dependence of *tef0* is turned-off & new formulation for BE-recombination current is active

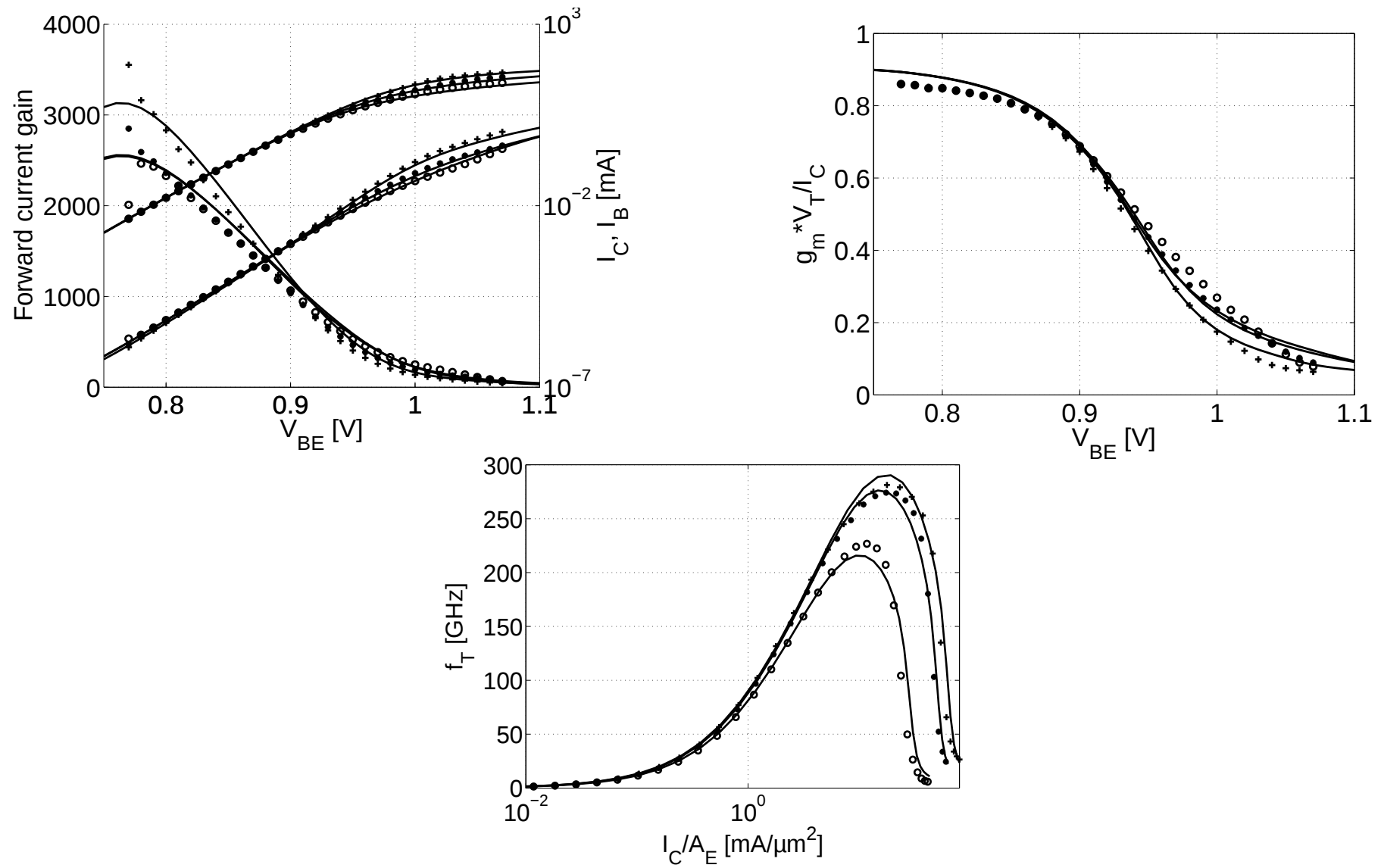
Newly added model parameters

Parameter	Default	Description
δ_{CK}	2	Mobility field factor for I_{CK}
a_{hjEi}	0	Parameter describing the slope of $h_{jEi}(V_{BE})$
r_{hjEi}	1	Smoothing parameter for $h_{jEi}(V_{BE})$ at high voltage.
ΔV_{gBE}	0	Bandgap difference between base & BE-junction (for h_{jEi0} , h_{f0})
ζ_{hjEi}	1	Temperature coefficient for a_{hjEi}
ζ_{VgBE}	1	Temperature coefficient for h_{jEi0}
h_{f0}	1	Weight factor for the low current minority charge
V_{cBar}	0	Barrier voltage
a_{cBar}	1	Smoothing parameter for barrier voltage
i_{cBar}	1	Normalization parameter
ζ_{rth}	1	Temperature coefficient for R_{th}
K_{frE}	0	R_E flicker noise coefficient
A_{frE}	2	R_E flicker noise exponent factor

HICUM/L2 v2.30 experimental verification

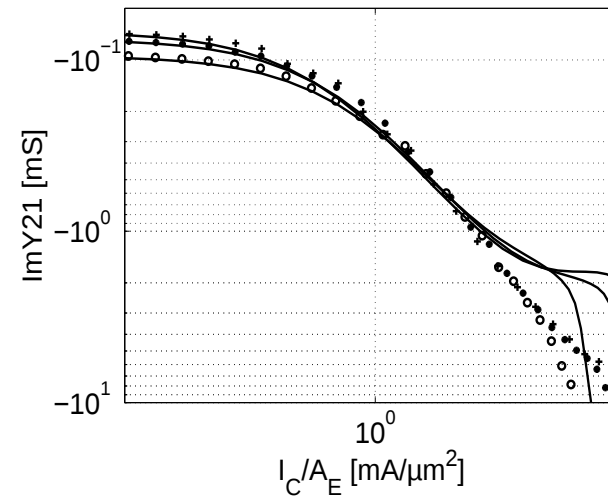
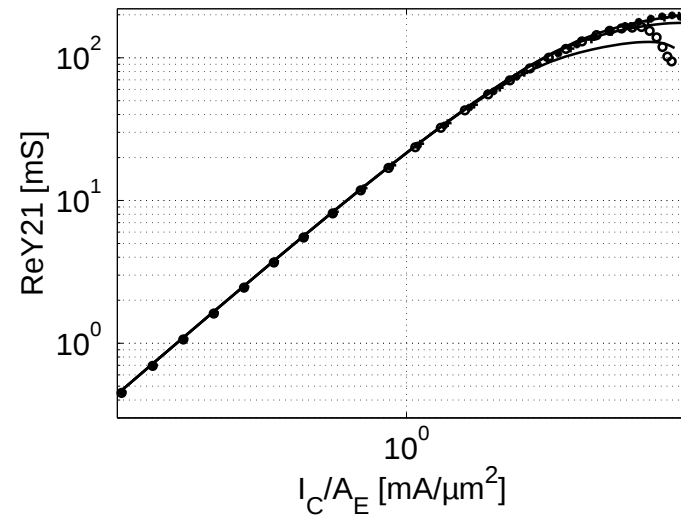
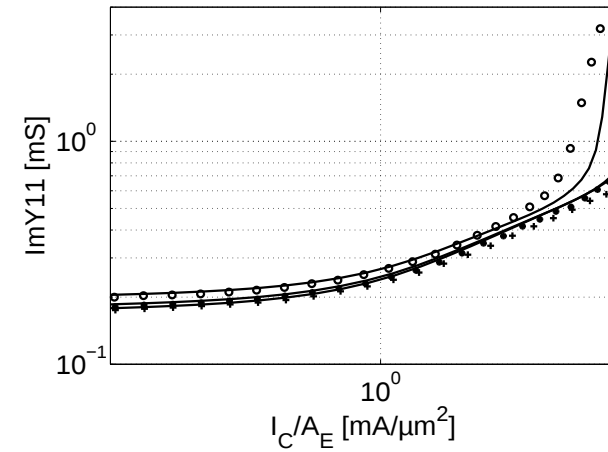
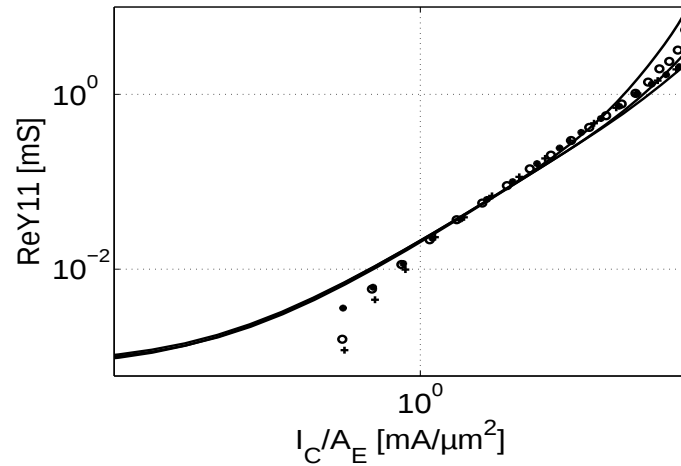
- various procss technologies: ST, IFX, IHP
- Selected results for advanced 250GHz (f_T) SiGe HBTs (from ST)
 - for more results see other presentations and upcoming publications
- Emitter area $A_E = 0.582\mu m^2$
- Results are for $V_{BC} = \{0.5, 0, -0.5\}V$
- Verification for different temperatures: $\{-40, 27, 125\} ^\circ C$
- Symbols: Measured data, Lines: Hicum/L2v2.30

HICUM/L2 v2.30 verification @-40°C

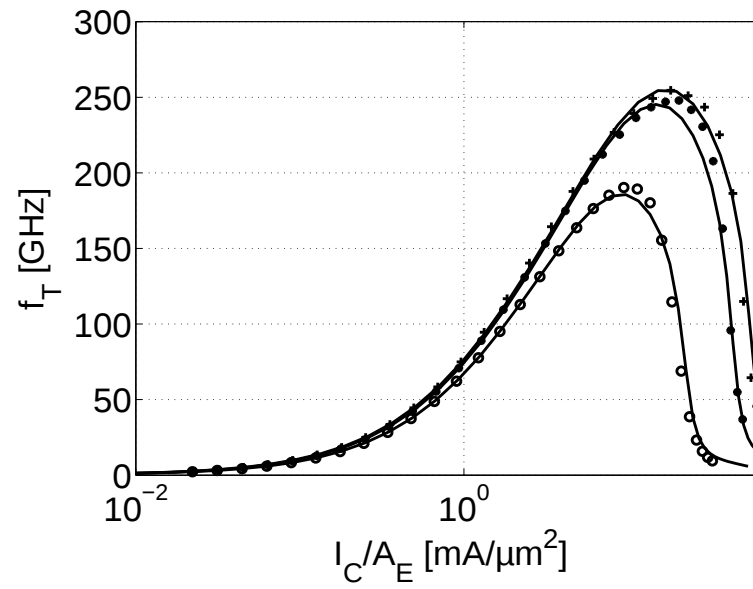
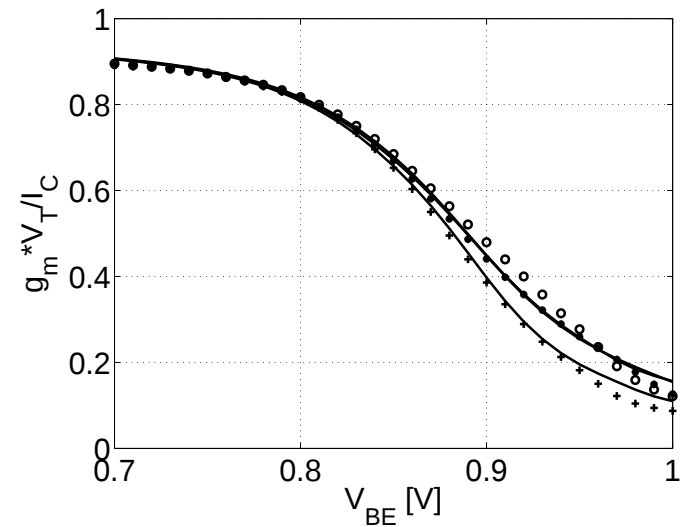
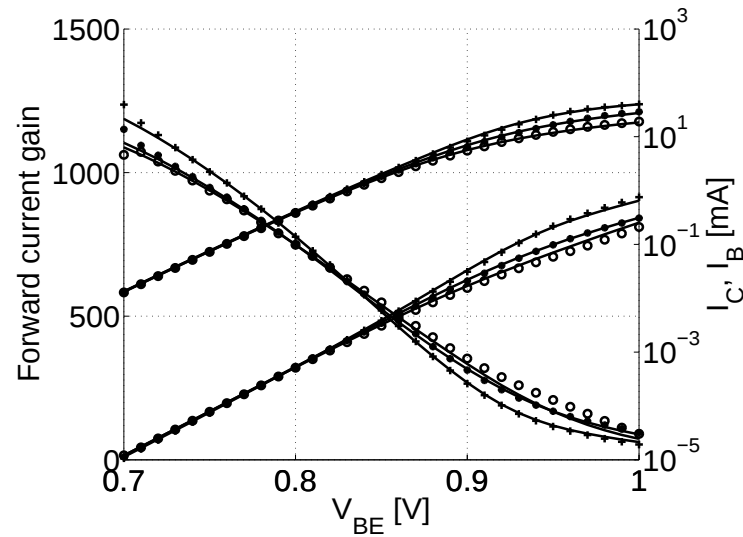


HICUM/L2 v2.30 verification (cont'd.) @-40°C

y-parameters @1GHz

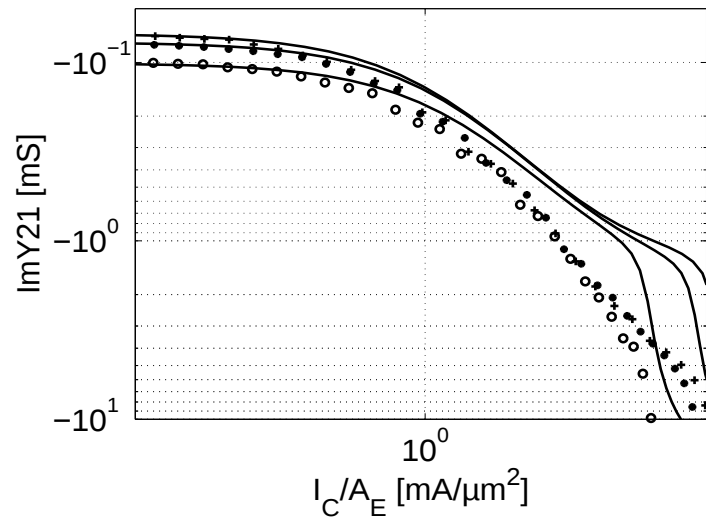
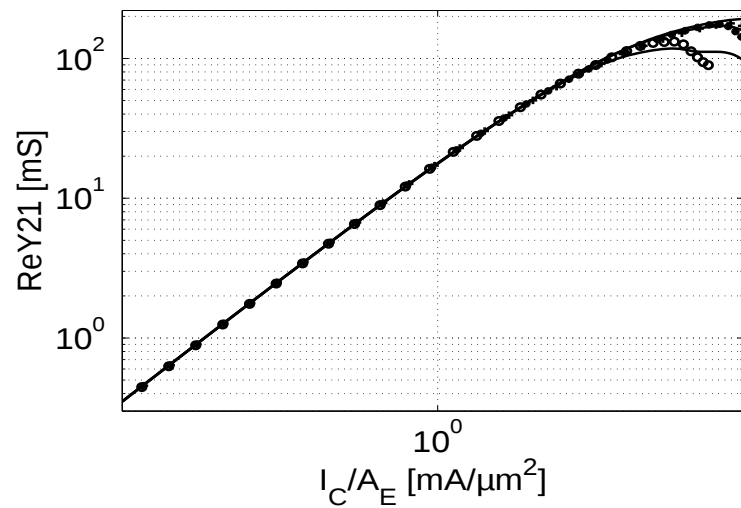
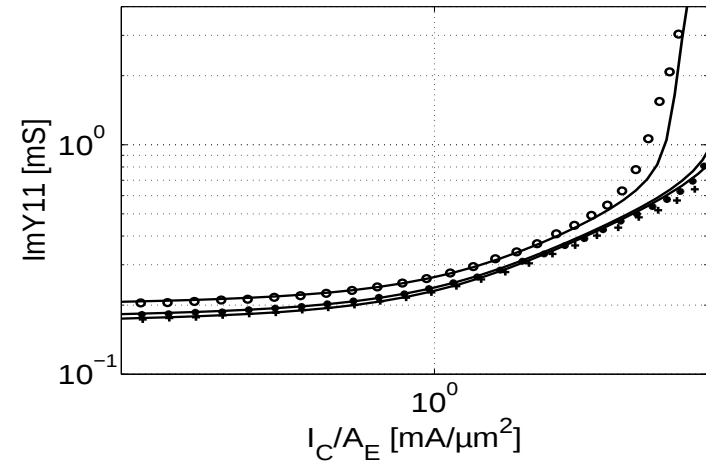
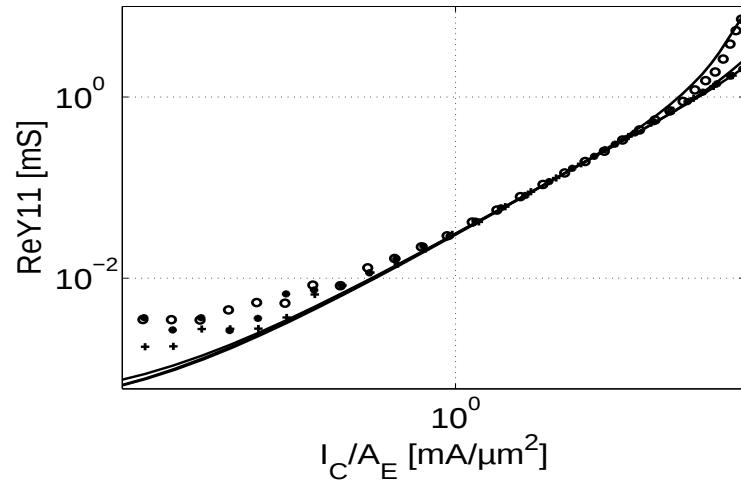


HICUM/L2 v2.30 verification (cont'd.) @27 °C

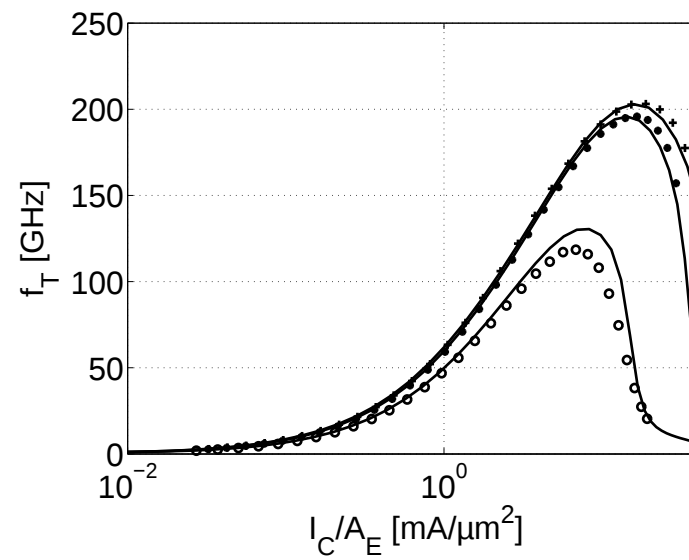
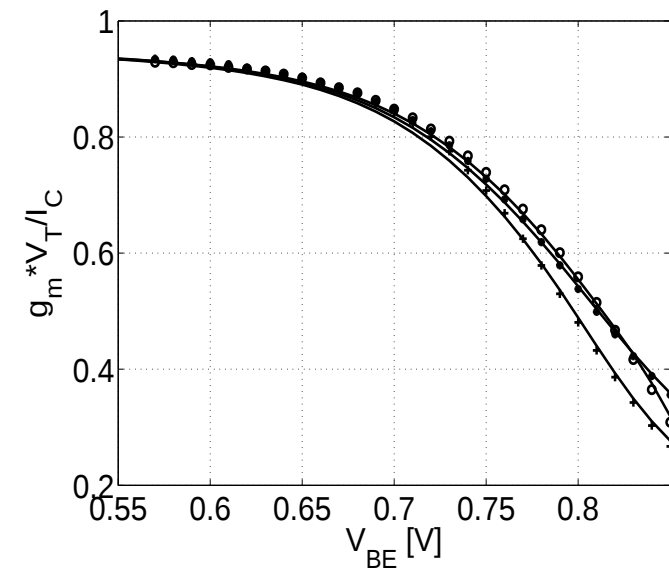
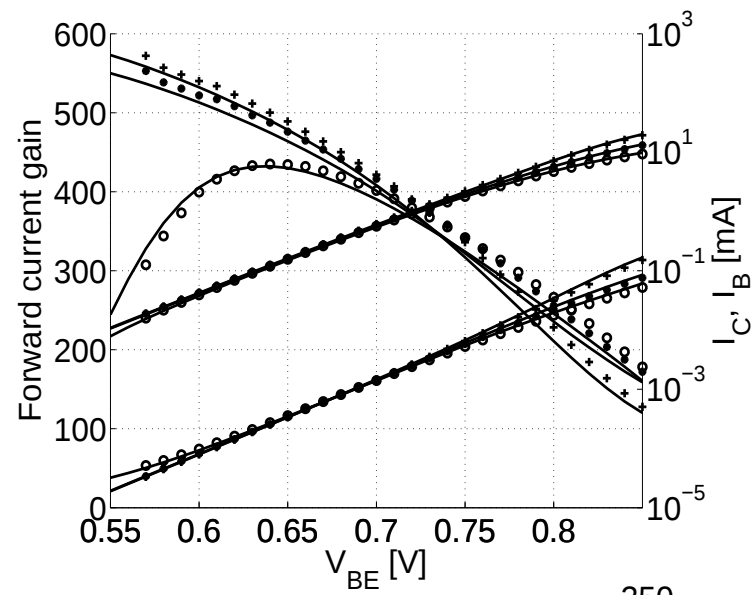


HICUM/L2 v2.30 verification (cont'd.) @27 °C

y-parameters @1GHz

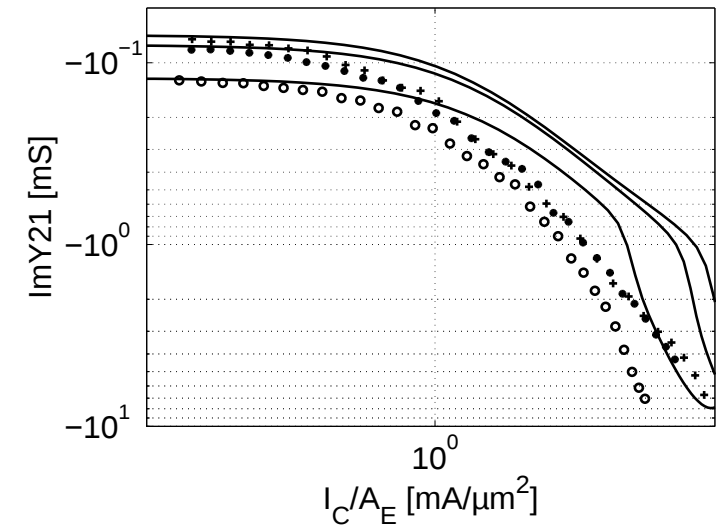
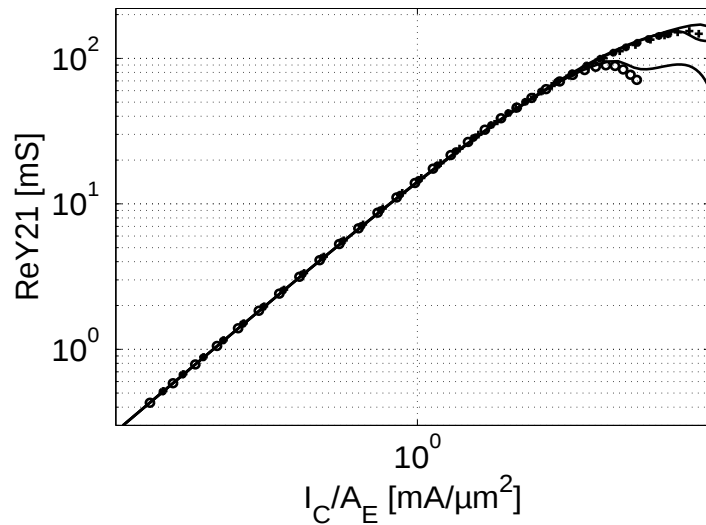
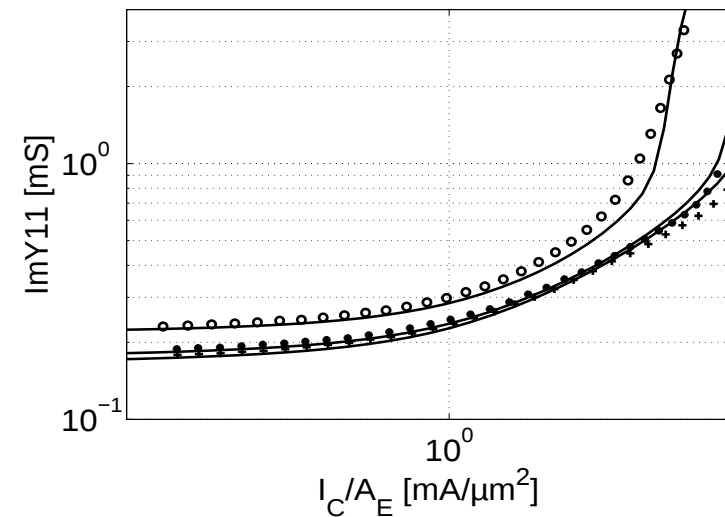
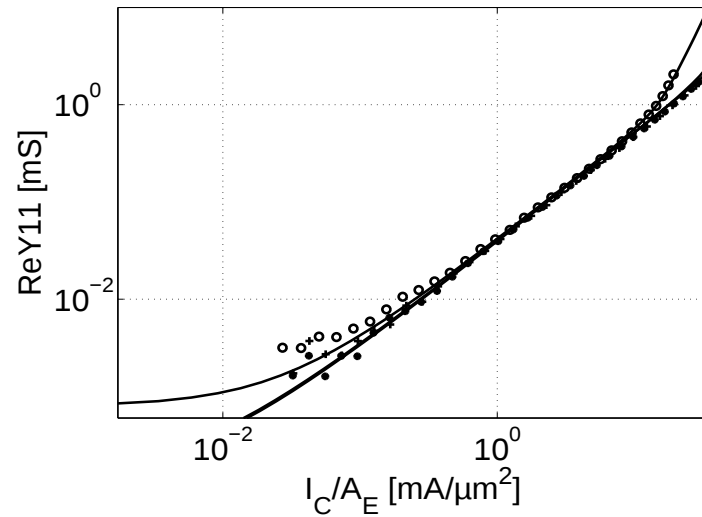


HICUM/L2 v2.30 verification (cont'd.) @125 °C



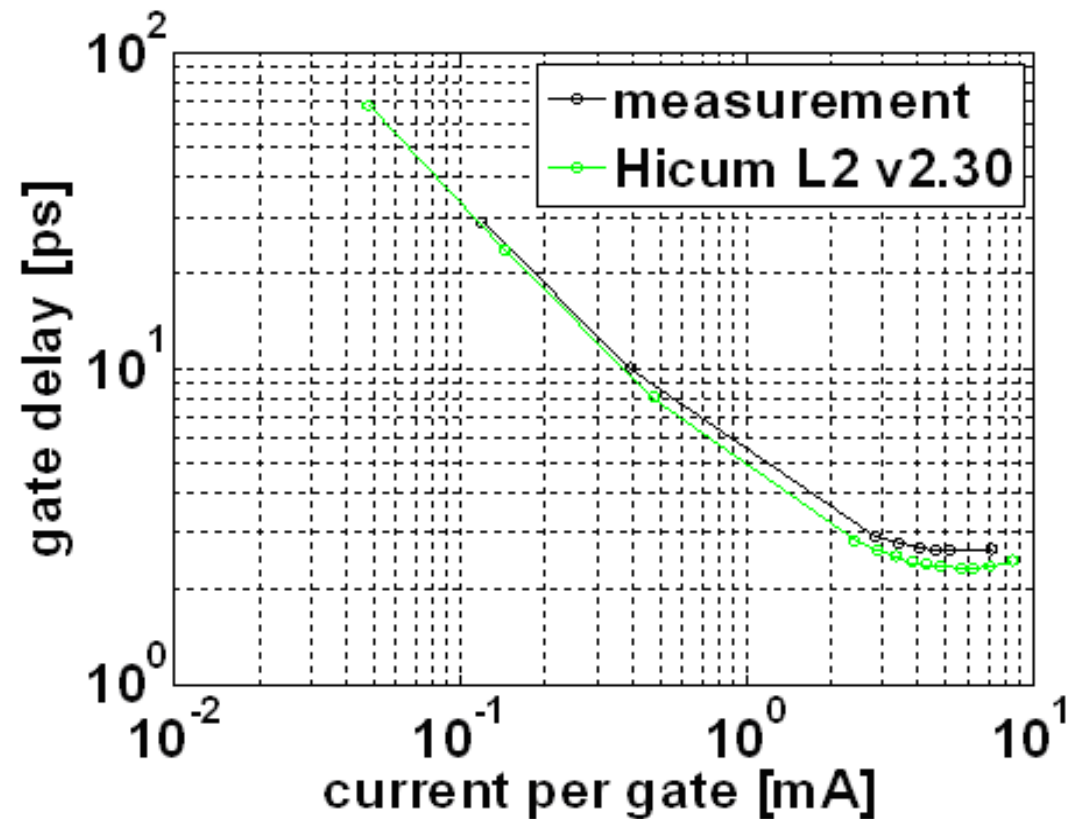
HICUM/L2 v2.30 verification (cont'd.) @125 °C

y-parameters @1GHz



HICUM/L2 v2.30 verification (cont'd.)

- CML Ring-Oscillator
 - HBT with $0.25 \times 2.8 \mu\text{m}^2$ emitter mask size (CEB contact configuration)



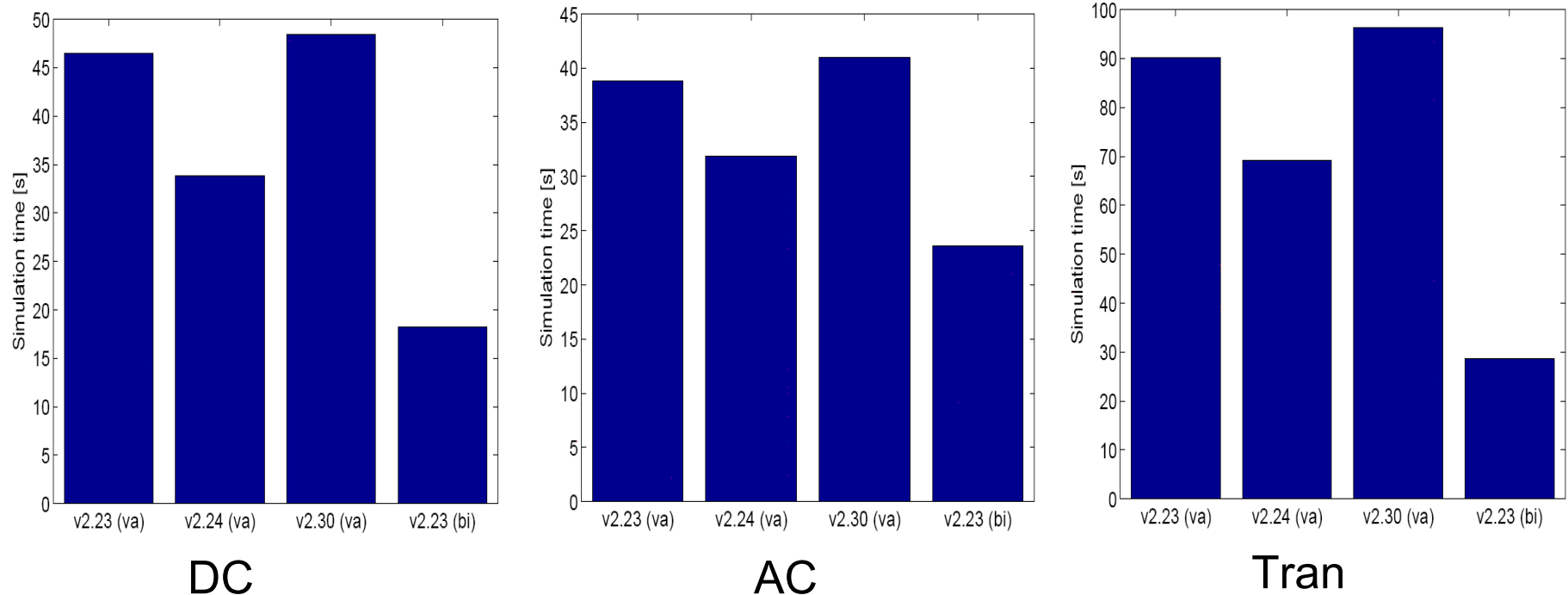
Ref: DotFive Deliverable report4.1.3

Model Run-Time Comparison

- Test bench:
 - DC-simulation: 20 devices in parallel, 17600 operating points
 - AC-simulation: 1 device, 187 operating points, 1500 frequency points
 - Transient simulation: ring-oscillator with 31 CML stages with two transistors
- HICUM versions tested:
 - HICUM Level 2, version 2.23 (Verilog-A code)
 - HICUM Level 2, version 2.24 (Verilog-A code)
 - HICUM Level 2, version 2.30 (Verilog-A code)
 - HICUM Level 2, version 2.23 (latest available ADS & Spectre built-in version)
- All newly implemented effects in Hicum/L2v2.30 are turned-off to obtain meaningful comparisons (need to use identical parameter sets with v2.23 as the least common denominator!!)

Model Run-Time Comparison (cont'd.)

- Simulator: ADS (ADS2009U1), time in (s)

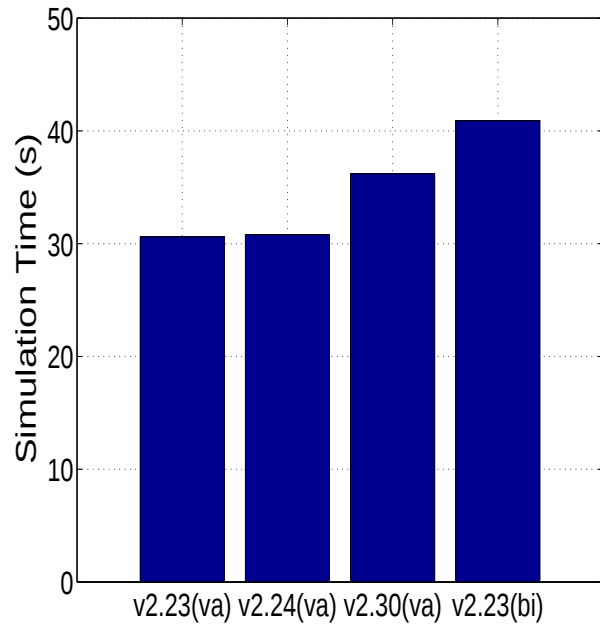


- **Observation**

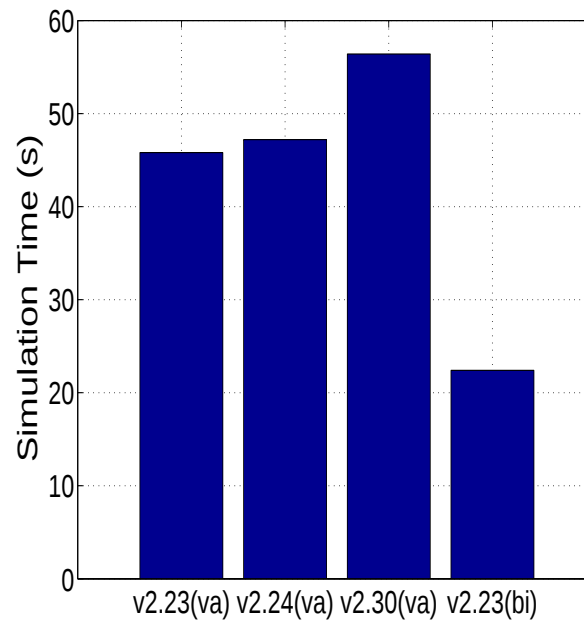
- The ADS built-in model runs ~50% faster except for AC simulation
- Less time taken by V2.24 clearly shows absence of "ddx" operator

Model Run-Time Comparison (cont'd.)

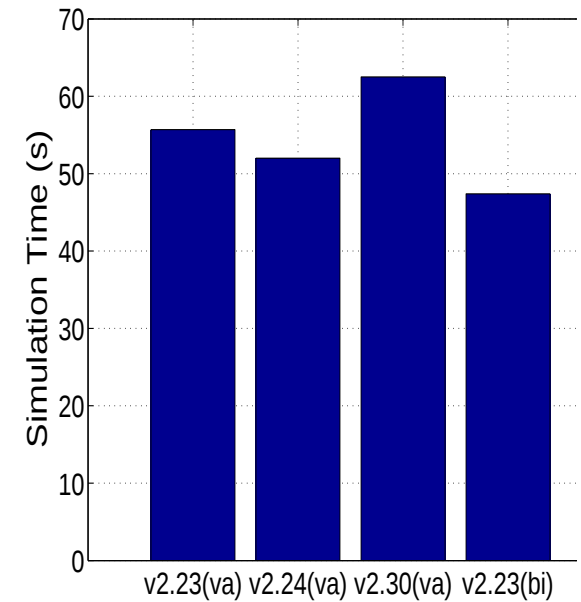
- Simulator: Spectre (MMSIM 7.2), time in second



DC



AC



Tran

- **Observation**

- Spectre built-in version takes 30% more time than Verilog-A code in DC case
=> may be optimization problem during implementation

HICUM/L0 Support Activities

- Released new HICUM/L0 v1.3 => available on website since Feb. 2011
 - Developed primarily in cooperation with ST
- *Access of source code restricted to users providing support for model development and implementation (not CMC "regulations" restricted)*
 - Cadence received the code for implementation
- Primary features of HICUM/L0 v1.3
 - "*Gmin* (=1e-12)" implemented between collector and emitter node
 - *AHQ*, *ZETA/QF* changed to their proper names
 - Low-injection (junction related) base charge *qj* is now limited to positive value
 - Implementation of direct solution for transfer current
 - Cardano's method used for solving third order charge equation
 - *it_mod=0* turns-off & brings back previous model (v1.2) equations
 - Temperature dependence of emitter transit time *tef0* removed (= new default)
 - setting *tef_temp=1* makes former equations (v1.2) available

Conclusions

new version HICUM/L2 v2.3

- includes relevant effects in advanced HBTs through physics-based formulations
- applied to several advanced process technologies
=> excellent accuracy obtained
- was publicly released in May
- planned to be applied to a variety of different technologies (incl. HV HBTs)

runtime comparisons for v2.23: VA vs built-in

- DC results
 - VA: ADS **50% slower** than SPECTRE
 - built-in: ADS **3 times faster** than SPECTRE
- TR results for built-in: ADS **50% faster** than SPECTRE